LISTING OF THE CLAIMS

The following Listing of the Claims replaces all previous listings of the claims within this application.

No claims are amended or added herein.

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- 1. (original) A microelectronic fabrication facility information system comprising:
- 2 a series of databases having contained therein production information for microelectronic
- 3 fabrication product orders within a microelectronic fabrication facility; and
- 4 a microelectronic fabrication facility communication interface connected to the series of
- 4.5 databases, where the microelectronic fabrication facility communication interface serves as an
 - 6 interface to a distributed communication network and functions in a fashion which allows a
 - 7 microelectronic fabrication customer also connected to the distributed communications network
 - 8 to access the information within the series of databases.
 - 1 2. (original) The system of claim 1 wherein the system is incorporated into a microelectronic
 - 2 fabrication facility selected from the group consisting of integrated circuit microelectronic
 - 3 fabrication facilities, ceramic substrate microelectronic fabrication facilities, solar cell
 - 4 optoelectronic microelectronic fabrication facilities, sensor image array optoelectronic
 - 5 microelectronic facilities and display image array optoelectronic microelectronic fabrication
 - 6 facilities.
 - 1 3. (original) The system of claim 1 wherein the microelectronic fabrication facility
 - 2 communication interface is a computer server.
 - 4. (original) The system of claim 3 wherein the computer server has incorporated therein the
 - 2 series of databases.

- 1 5. (original) The system of claim 1 wherein the distributed communications network is selected
- 2 from the group consisting of local area networks, wide area networks, Internet networks and
- 3 intranet networks.
- 1 6. (original) The system of claim 1 wherein the distributed communications network is an
- 2 Internet distributed communications network.
- 1 7. (original) A method for operating a microelectronic fabrication facility information system
- 2 comprising:
- 3 providing a microelectronic fabrication facility information system comprising:
- 4 a series of databases having contained therein production information for
- 5 microelectronic fabrication product orders within a microelectronic fabrication facility; and
- a microelectronic fabrication facility communication interface connected to the
- 7 series of databases, where the microelectronic fabrication facility communication interface
- 8 serves as an interface to a distributed communication network and functions in a fashion which
- 9 allows a microelectronic fabrication customer also connected to the distributed communications
- 10 network to access the information within the series of databases;
- 11 providing the microelectronic fabrication customer connected to the distributed
- 12 communications network; and

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- 13 effecting access of the production information within the series of databases by the
- 14 microelectronic fabrication customer through the distributed communications network.

- 1 8. (original) The method of claim 7 wherein the system is incorporated into a microelectronic
- 2 fabrication facility selected from the group consisting of integrated circuit microelectronic
- 3 fabrication facilities, ceramic substrate microelectronic fabrication facilities, solar cell
- 4 optoelectronic microelectronic fabrication facilities, sensor image array optoelectronic
- 5 microelectronic facilities and display image array optoelectronic microelectronic fabrication
- 6 facilities.
- 1 9. (original) The method of claim 7 wherein the microelectronic fabrication facility
- 2 communication interface is a computer server.
- 1 10. (original) The method of claim 9 wherein the computer server has incorporated therein the
- 2 series of databases.
- 1 11. (original) The method of claim 7 wherein the distributed communications network is
- 2 selected from the group consisting of local area networks, wide area networks, Internet networks
- 3 and intranet networks.
- 1 12. (original) The method of claim 7 wherein the distributed communications network is an
- 2 Internet distributed communications network.
- 1 13. (previously presented) The microelectronic fabrication information system of claim 1
- 2 wherein the microelectronic fabrication information system allows for a customer to access to
- 3 the customer's product order information within the microelectronic fabrication facility.

- 1 14. (previously presented) The method of claim 7 wherein the microelectronic fabrication
- 2 information system allows for a customer to access to the customer's product order within the
- 3 microelectronic fabrication facility.